

FDC640P Datasheet



DiGi Electronics Part Number

Manufacturer

Manufacturer Product Number

Description

Detailed Description

onsemi

FDC640P

FDC640P-DG

MOSFET P-CH 20V 4.5A SUPERSOT6

P-Channel 20 V 4.5A (Ta) 1.6W (Ta) Surface Mount SuperSOT^M-6

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
FDC640P	onsemi
Series:	Product Status:
PowerTrench®	Active
FET Type:	Technology:
P-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (ld) @ 25°C:
20 V	4.5A (Ta)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
2.5V, 4.5V	53mOhm @ 4.5A, 4.5V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
1.5V @ 250µA	13 nC @ 4.5 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±12V	890 pF @ 10 V
FET Feature:	Power Dissipation (Max):
-	1.6W (Ta)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
SuperSOT™-6	SOT-23-6 Thin, TSOT-23-6
Base Product Number:	
FDC640	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0095	

onsemi

MOSFET – P-Channel, POWERTRENCH[®], Specified

2.5 V

FDC640P

General Description

This P–Channel 2.5 V specified MOSFET uses a rugged gate version of **onsemi**'s advanced POWERTRENCH process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5 V - 12 V).

Features

- -4.5 V, -20 V. $R_{DS(ON)} = 0.053 \ \Omega \ @ V_{GS} = -4.5 V$ $R_{DS(ON)} = 0.080 \ \Omega \ @ V_{GS} = -2.5 V$
- Rugged Gate Rating (±12 V)
- Fast Switching Speed
- High Performance Trench Technology for Extremely Low RDS(ON)
- This is a Pb–Free and Halide Free Device

Applications

- Battery Management
- Load Switch
- Battery Protection

ABSOLUTE MAXIMUM RATINGS $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Value	Unit
V _{DSS}	Drain-Source Voltage	-20	V
V _{GSS}	Gate-Source Voltage	±12	V
۱ _D	Drain Current –Continuous (Note 1a.) –Pulsed	-4.5 -20	A
P _D	Maximum Power Dissipation (Note 1a.) (Note 1b.)	1.6 0.8	W
T _J , T _{STG}	Operating and Storage Junction Temperature Range	–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Symbol	Parameter	Value	Unit
R _{θJA}	Thermal Resistance, Junction-to-Ambient (Note 1a.)	78	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case (Note 1)	30	°C/W

V _{DSS}	R _{DS(ON)} MAX	I _D MAX
–20 V	0.053 Ω @ –4.5 V	-4.5 A
	0.080 Ω @ –2.5 V	



TSOT23 6–Lead (SUPERSOT [™] –6) CASE 419BL



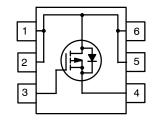


640 = Specific Device Code M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

PIN ASSIGNMENT



ORDERING INFORMATION

Device	Package	Shipping [†]
FDC640P	TSOT-23-6 (SUPERSOT™-6) (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

FDC640P onsemi MOSFET P-CH 20V 4.5A SUPERSOT6

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ELECTRICAL CHARACTERISTICS $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit		
OFF CHARACT	OFF CHARACTERISTICS							
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I _D = -250 μ A	-20	-	-	V		
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C	-	-14	-	mV/°C		
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1	μΑ		
I _{GSSF}	Gate-Body Leakage, Forward	V_{GS} = 12 V, V_{DS} = 0 V	-	-	100	nA		
I _{GSSR}	Gate-Body Leakage, Reverse	V_{GS} = -12 V, V_{DS} = 0 V	-	-	-100	nA		

ON CHARACTERISTICS (Note 2)

V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, \ I_D = -250 \ \mu A$	-0.6	-1.0	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C	-	3	-	mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$\begin{split} V_{GS} &= -4.5 \text{ V}, \text{ I}_D = -4.5 \text{ A} \\ V_{GS} &= -2.5 \text{ V}, \text{ I}_D = -3.6 \text{ A} \\ V_{GS} &= -4.5 \text{ V}, \text{ I}_D = -4.5 \text{ A}, \text{ T}_J = 125^\circ\text{C} \end{split}$	- - -	0.039 0.062 0.053	0.053 0.080 0.077	Ω
I _{D(on)}	On-State Drain Current	V_{GS} = -4.5 V, V_{DS} = -5 V	-20	-	-	А
9 FS	Forward Transconductance	V_{GS} = –5 V, I_D = –4.5 A	_	16	-	S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	$V_{DS} = -10$ V, $V_{GS} = 0$ V, f = 1.0 MHz	_	890	_	pF
C _{oss}	Output Capacitance		-	244	-	pF
C _{rss}	Reverse Transfer Capacitance		-	123	-	pF

SWITCHING CHARACTERISTICS (Note 2)

t _{d(on)}	Turn-On Delay Time	$V_{DD} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ A},$	-	12	22	ns
t _r	Turn–On Rise Time	V _{GS} = -4.5 V, R _{GEN} = 6 Ω	-	9	18	ns
t _{d(off)}	Turn-Off Delay Time		-	24	38	ns
t _f	Turn-Off Fall Time		-	13	23	ns
Qg	Total Gate Charge	$V_{DS} = -10 \text{ V}, \text{ I}_D = -4.5 \text{ A},$ $V_{GS} = -4.5 \text{ V}$	-	9	13	nC
Q _{gs}	Gate-Source Charge	$v_{GS} = -4.5 v$	-	2	-	nC
Q _{gd}	Gate-Drain Charge		_	3	_	nC

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS

۱ _S	Maximum Continuous Drain-Source Diode Forward Current		-	-	-1.3	А
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = -1.3 \text{ A} \text{ (Note 2)}$	-	-0.7	-1.2	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. NOTES:

 R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.
a.78°C/W when mounted on a 1in² pad of 2oz copper on FR-4 board.

b.156°C/W when mounted on a minimum pad.

2. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

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TYPICAL CHARACTERISTICS

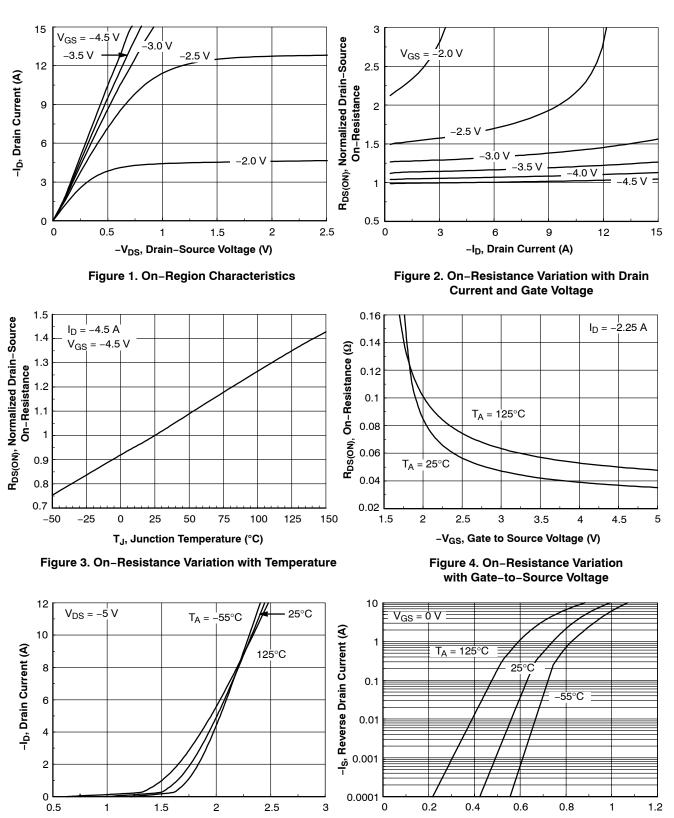




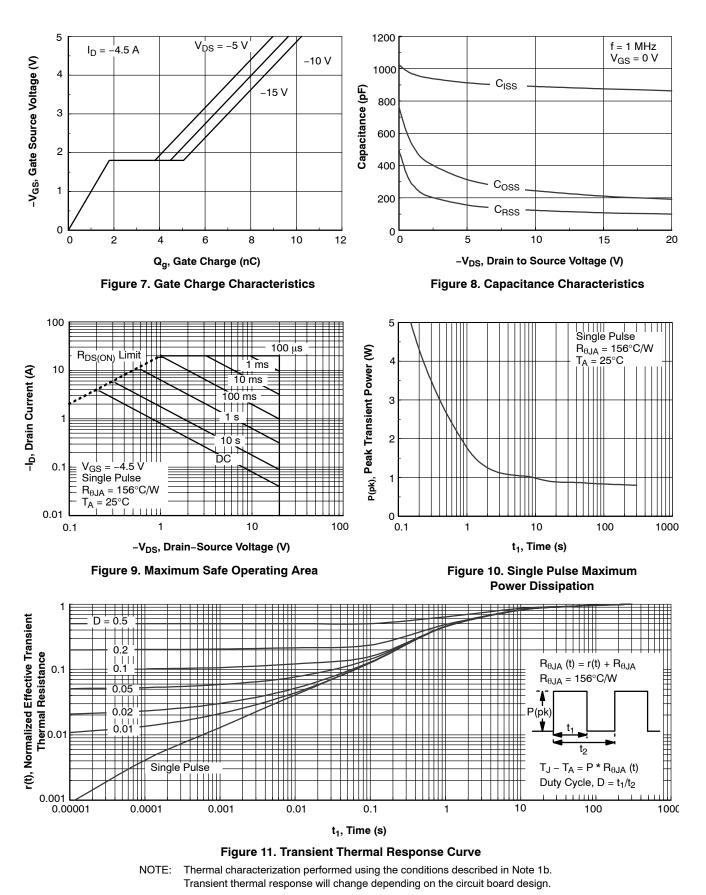
Figure 5. Transfer Characteristics

Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

-V_{SD}, Body Diode Forward Voltage (V)

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TYPICAL CHARACTERISTICS (continued)



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PACKAGE DIMENSIONS

TSOT23 6-Lead CASE 419BL **ISSUE A** DATE 31 AUG 2020 SCALE 2:1 NOTES 0.20 C A 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009. CONTROLLING DIMENSION: MILLIMETERS
DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, В 6 PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.25MM PER END. DIMENSIONS D AND E1 ARE PIN 1 IDENTIFIER DETERMINED AT DATUM H. 4. SEATING PLANE IS DEFINED BY THE TERMINALS. E1 E "A1" IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY. MILLIMETERS DIM MIN. NOM. MAX. 0.20 C 0.90 А 1.00 1.10 3 A1 0.10 0.00 0.05 e -b 1.00 A2 0 70 0.85 e1 d A3 0.25 BSC TOP VIEW 0.25 0.38 0.50 b SEE DETAIL A С 0.10 0.18 0.26 // 0.10 C А н D 2.80 2.95 3.10 0.30 REF h A2 Е 2.50 2.75 3.00 SEATING 0.10 C 1.30 1.50 1.70 E1 A1 Ċ PLANE е 0.95 BSC NOTE 4 1.90 BSC e1 SIDE VIEW FRONT VIEW L1 0.60 REF SYMM L2 0.20 0.40 0.60 10° Ę θ 0° ----GAGE PLANE 0.95 -0.95 1.00 MIN A3 2.60 SEATING PLANE ·L1 DETAIL A 0.70 MIN GENERIC **MARKING DIAGRAM*** LAND PATTERN RECOMMENDATION *FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES XXX M= 0 -REFERENCE MANUAL, SOLDERRM/D. 1 XXX = Specific Device Code = Date Code Μ = Pb-Free Package . (Note: Microdot may be in either location) *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " .", may or may not be present. Some products may not follow the Generic Marking. Electronic versions are uncontrolled except when accessed directly from the Document Repository. DOCUMENT NUMBER: 98AON83292G Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. **DESCRIPTION:** TSOT23 6-Lead PAGE 1 OF 1 onsemi and OnSemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

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